



**THE DATASHEET OF
W3011**



Description: 1.575 GHz GNSS Ceramic
Chip Antenna

Series: Ceramic Chip Antenna

PART NUMBER: W3011



Features:

- Frequency 1559-1606.6MHz
- Gain 1 / 1.8 / 1.4dBi
- Size 3.2 x 1.6 x 1.1 mm
- PCB Keep out 4 x 4.25 mm
- Polarization Linear
- Radiation pattern Omni

Applications:

- L1 GNSS Receivers
- Beidou, GPS, Galileo
Glonass
- IoT, M2M
- Asset tracking
- Portable satellite receivers

All dimensions are in mm / inches

Issue: 2019

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ELECTRICAL SPECIFICATIONS

Antenna Type	Chip antenna
Frequency	1559-1563MHz 1574.4-1576.4MHz 1598.6-1606.6MHz
Nominal Impedance	50 Ω
Return Loss (Max)	-6 / -10 / -7 dB
Radiation Pattern	Omni
Gain(Min)	1 / 1.8 / 1.4dBi
Efficiency(Min)	50 / 68 / 60 %
Polarization	Vertical
Power Withstanding	2W

MECHANICAL SPECIFICATIONS

Compact size	3.2 x 1.6 x 1.1mm
Weight	0.033g
Fixing system	SMT
MSL(MOISTURE SENSITIVITY LEVEL)	1

ENVIRONMENTAL SPECIFICATIONS

Operating Temperature	-40 ~ +85° C
Storage Temperature	-40 ~ +85° C
RoHS Compliant	Yes

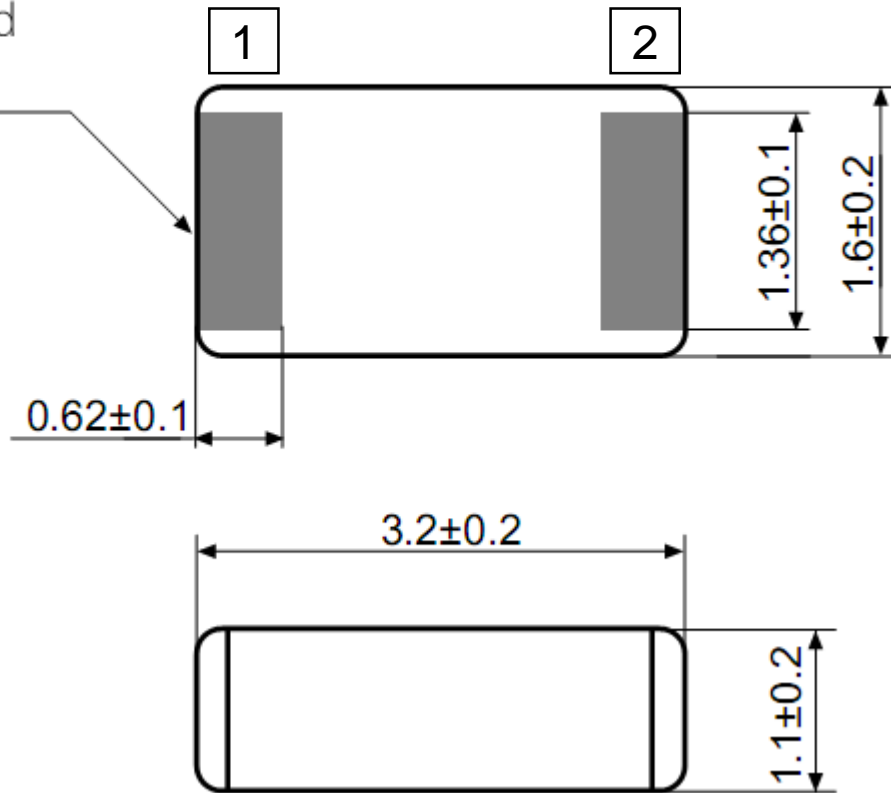
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MECHANICAL DRAWING

Ag metallization contact pad area (2x)



Antenna features

No.	Terminal name	Terminal Dimensions
1	Feed / GND	0.62 x 1.36 mm
2	Feed / GND	0.62 x 1.36 mm

Antenna is symmetrical.

Either of terminals 1 or 2 can be feed / GND

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W3011 GPS Antenna PWB Layout

Ground cleared under antenna, clearance area 4.00 x 4.25 mm
Matching and tuning component value and placement depend on
application and surrounding mechanics / materials.

Feed line should be designed to match 50 Ω characteristic
impedance, depending on PWB material and thickness.

Recommended test board layout for electrical characteristic
measurement, test board outline size 80 x 37 mm.

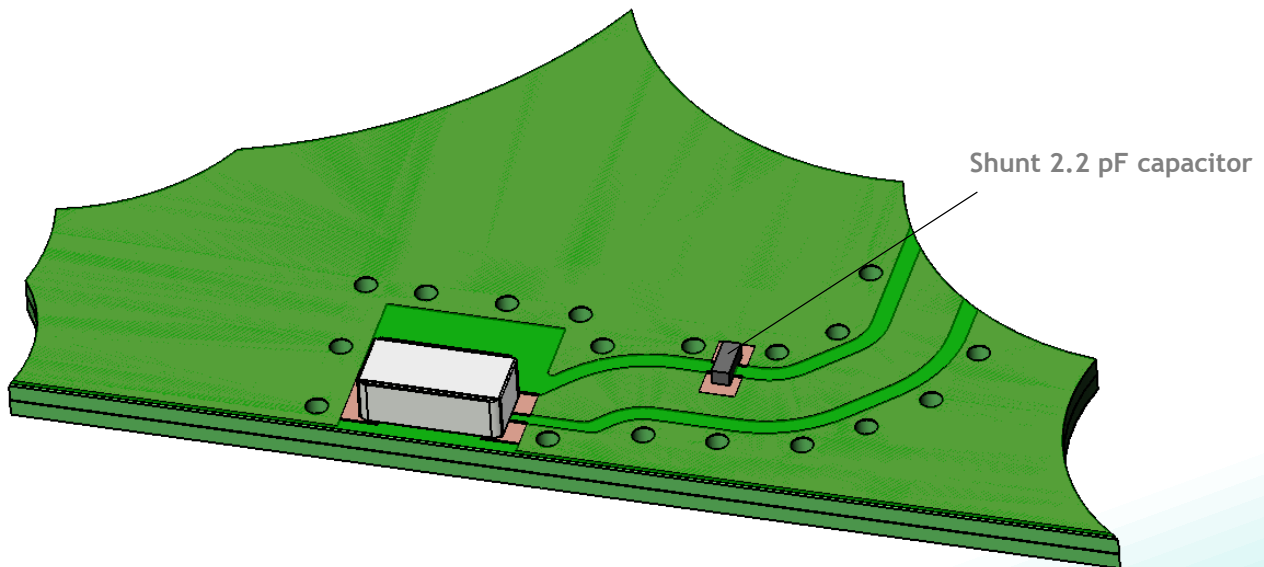
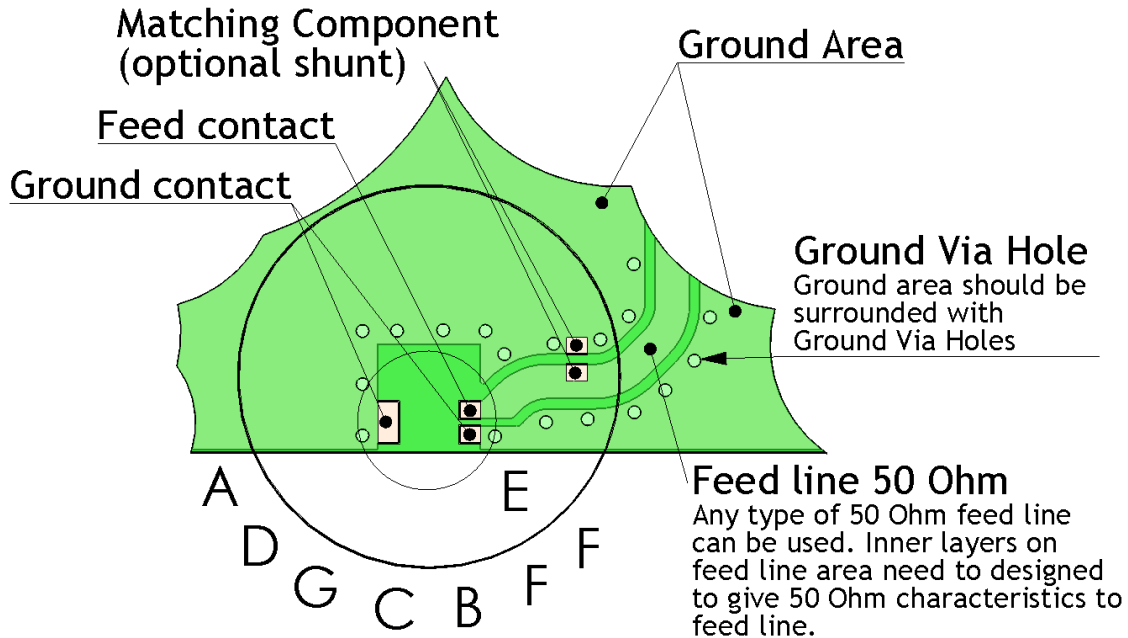
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PWB layout for W3011 GPS Antenna

Note: All dimensions are in metric system.



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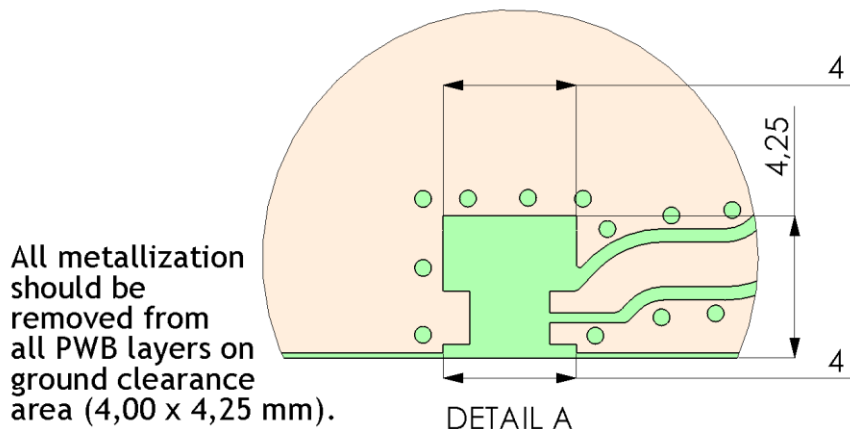
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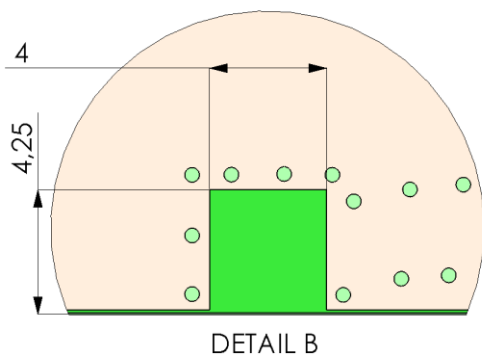
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Ground clearance area for W3011 GPS Antenna

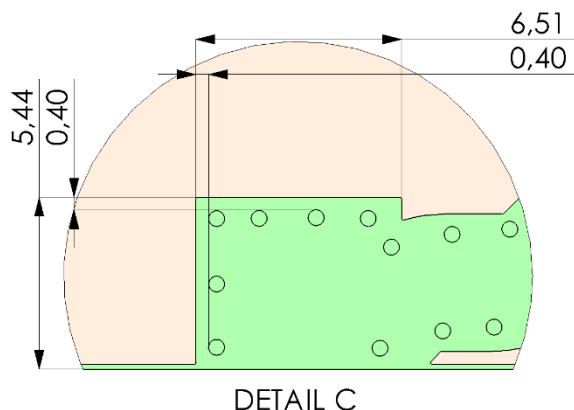
Ground clearance area (4,00 x 4,25 mm)



Opening in bottom/inner ground layers



Opening in other layers (no ground/ RF)



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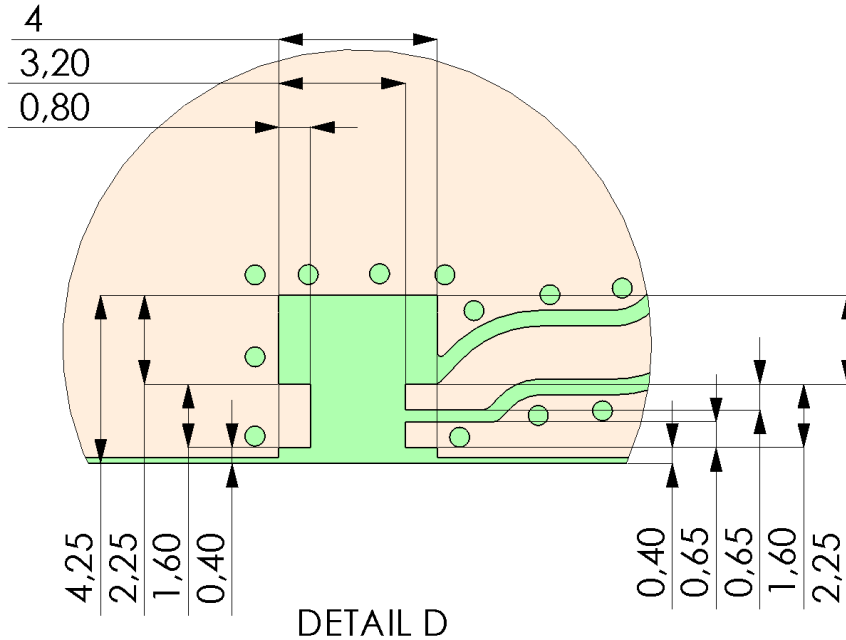
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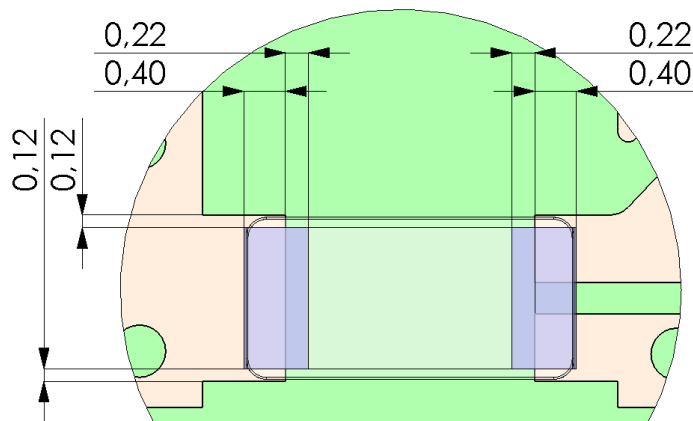
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PWB pad dimensions and antenna position for W3011 GPS Antenna

Pad dimensions in top copper



Antenna position on PWB layout



Antenna pads are marked blue
DETAIL E

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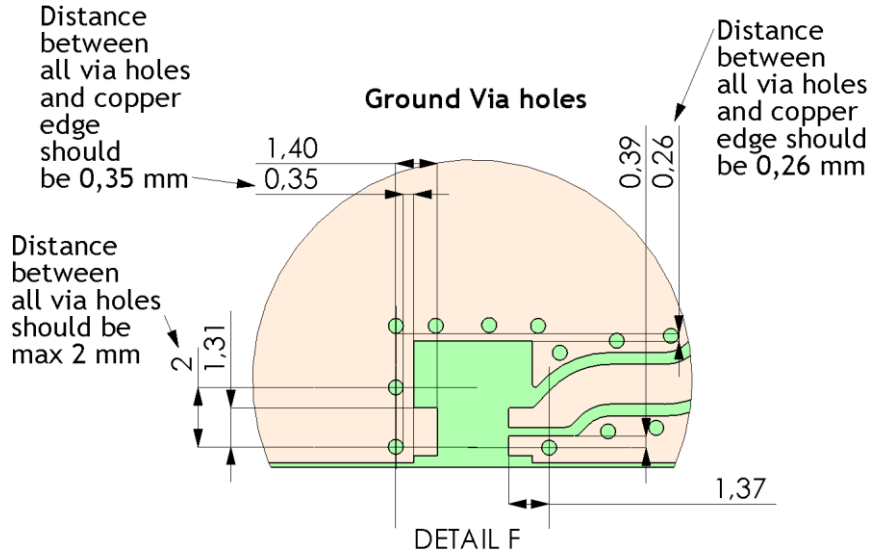
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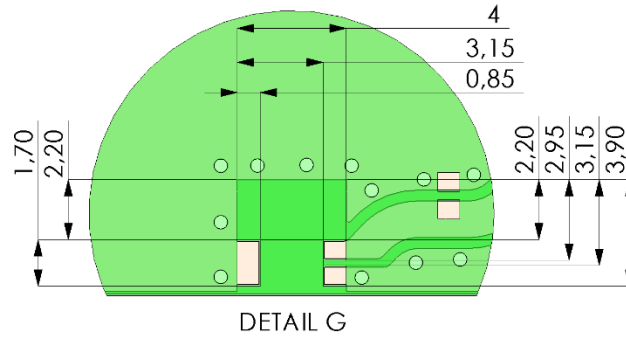
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Typical Ground via hole placement in PWB layout for W3011 GPS Antenna

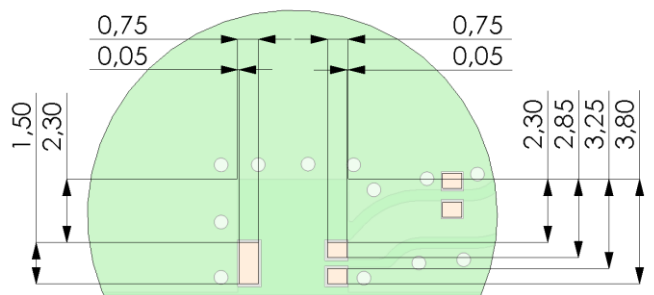


Solder resist opening and paste stencil recommendations for W3011 GPS Antenna

Solder resist opening



Paste stencil recommendation



Paste stencil thickness recommendation is 0.1 mm

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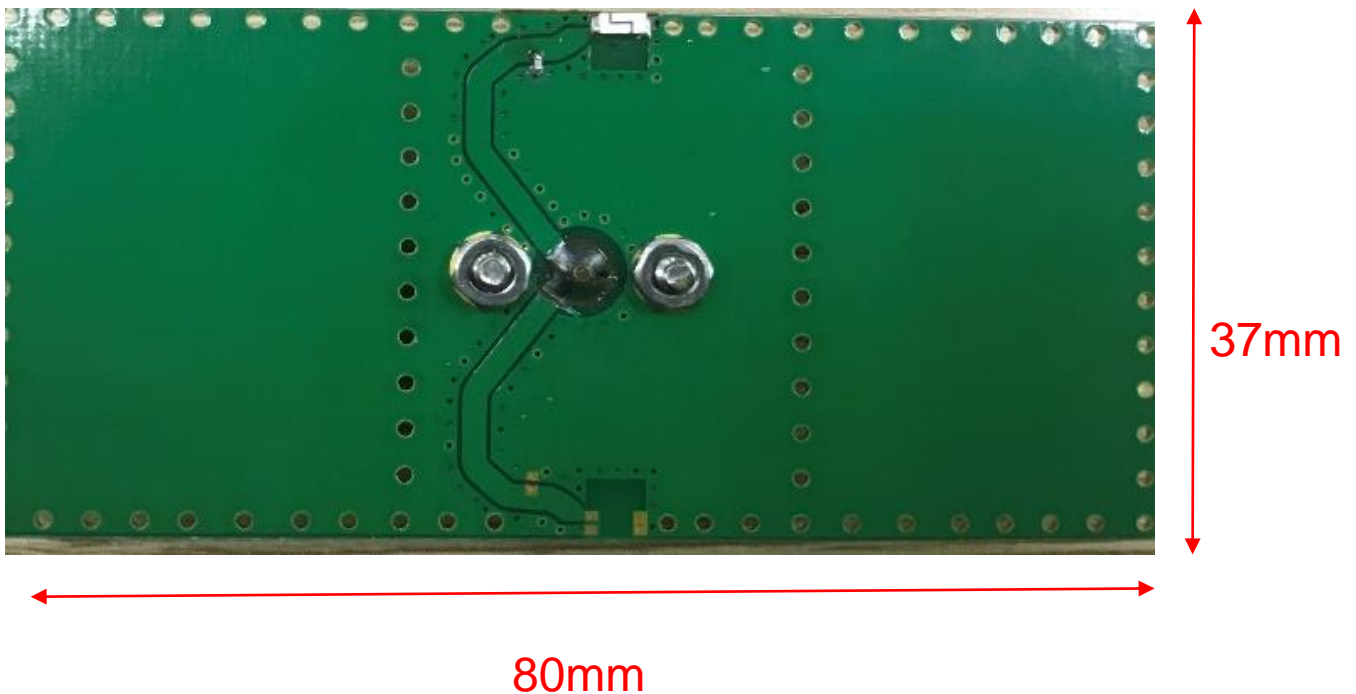
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TEST SETUP

All RF parameters tested on 80x37mm sized test board.
Antenna position on side center of PCB long edge.



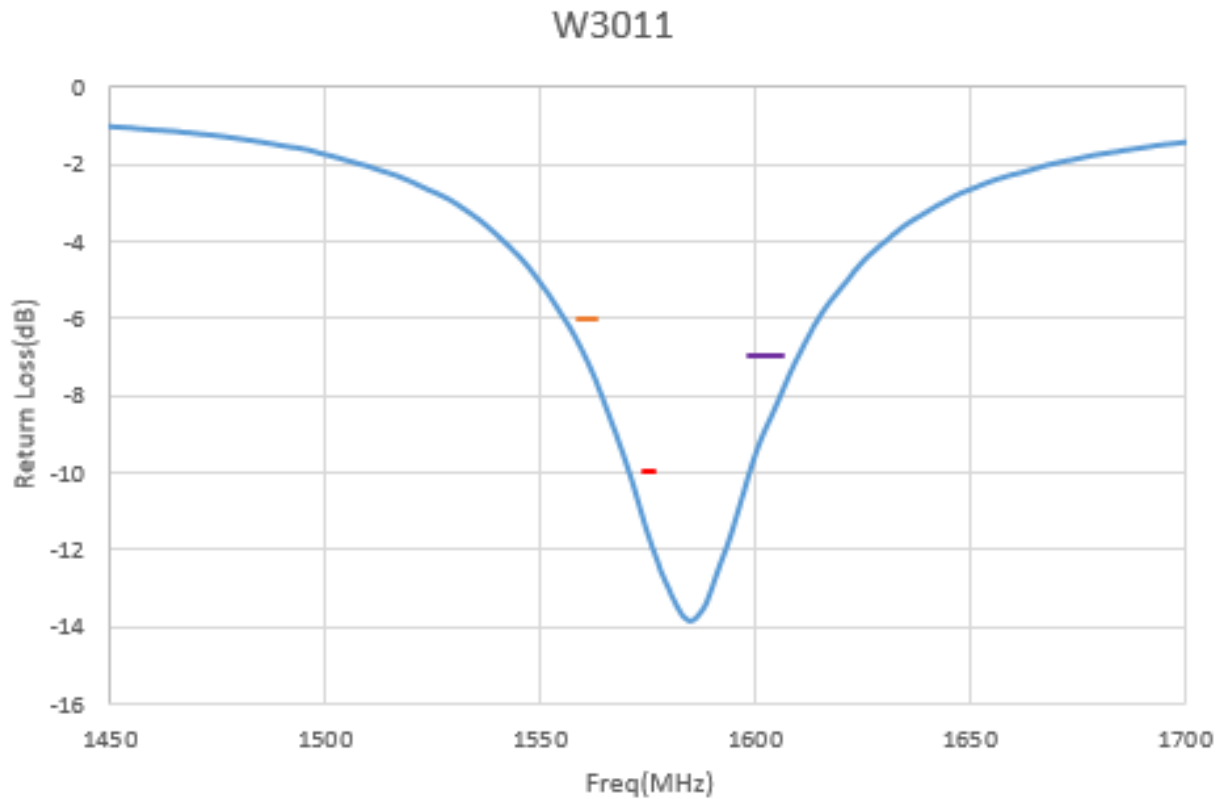
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CHARTS

Return Loss vs Frequency



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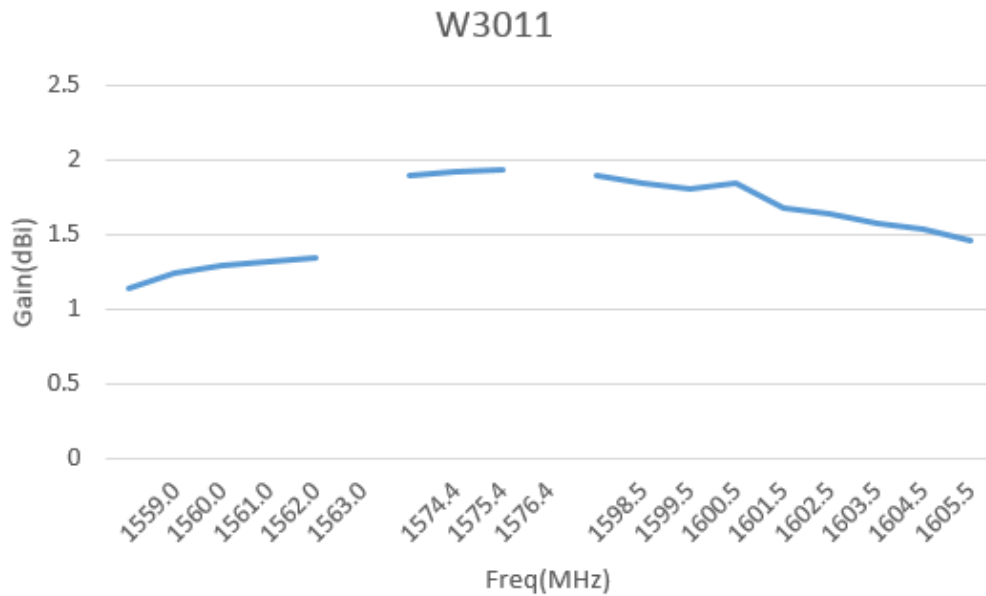
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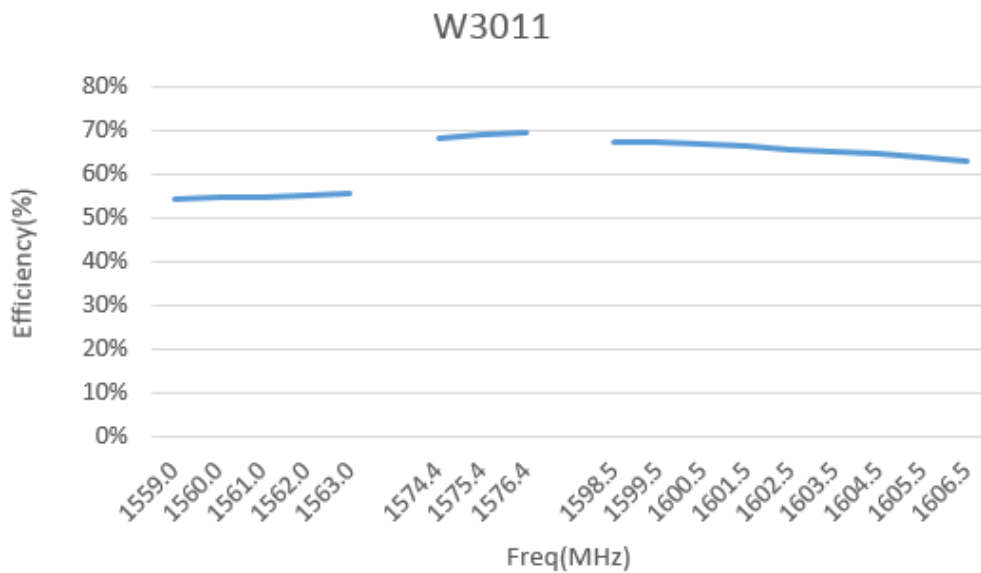
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CHARTS

Gain vs Frequency



Radiation Efficiency vs Frequency



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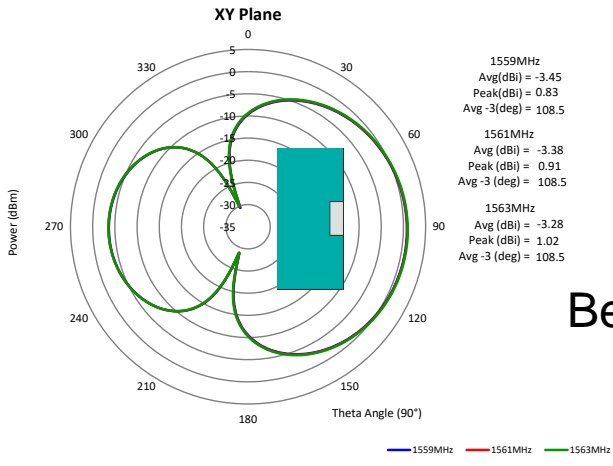
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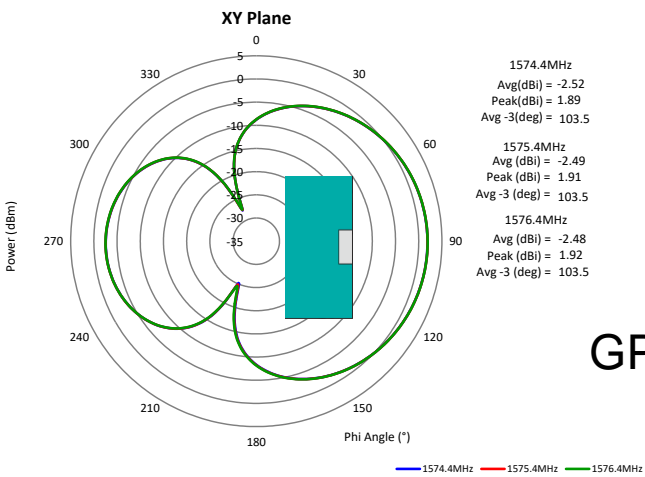
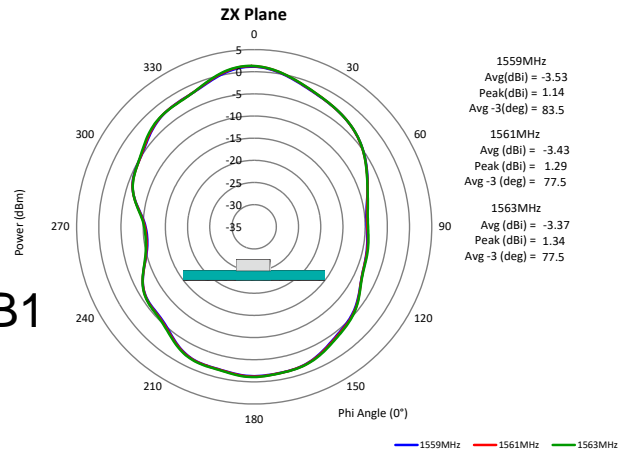
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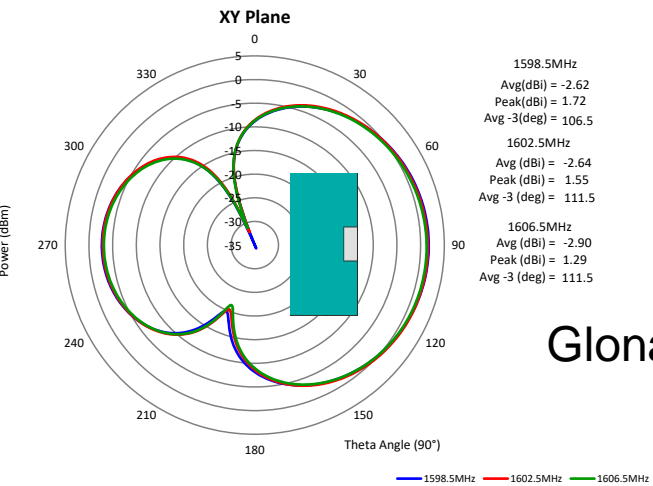
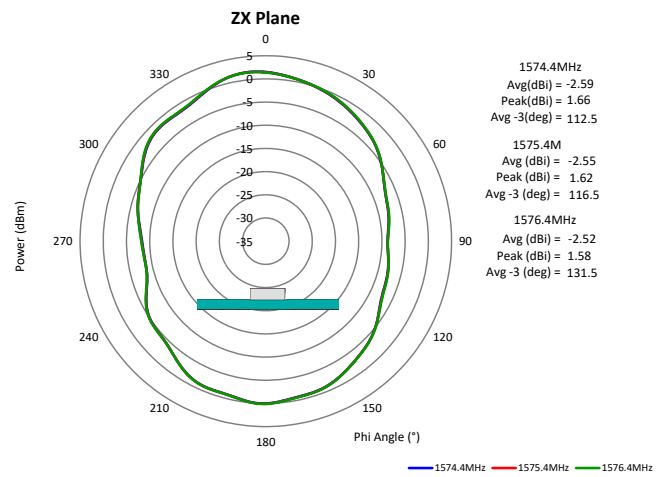
CHARTS



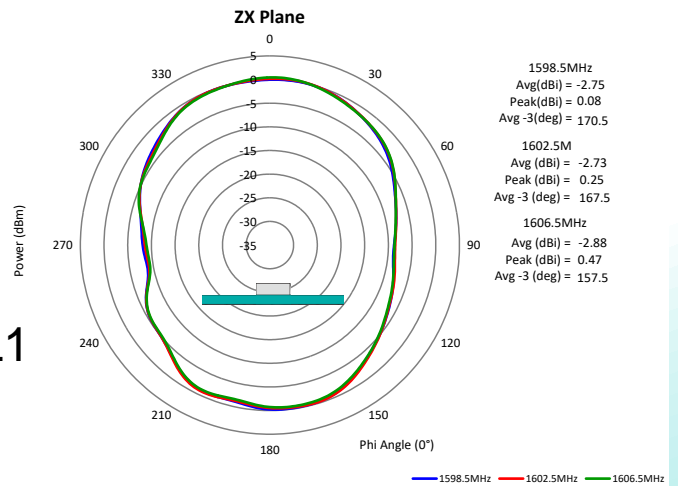
Beidou B1



GPS L1



Glonass L1



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Recommendation for reflow soldering process

Printing stencil thickness 0,15 - 0,25 mm is recommended for the solder paste. The maximum soldering temperature should not exceed 260°C. The temperature profile recommendations for reflow soldering process is presented in the Figures 1 and 2. The reflow profile

presented in figure 1 describes minimum reflow temperatures. The reflow profile presented in figure 2 describes maximum reflow temperatures. located at the center of the coverage area.

	Method of heat transfer	Controlled hot air convection
1	Average temperature gradient in preheating	2.5 °C/s
2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 30 sec
5	Peak temperature in reflow	230 °C for 10 seconds
6	Temperature gradient in cooling	Max -5 °C/s

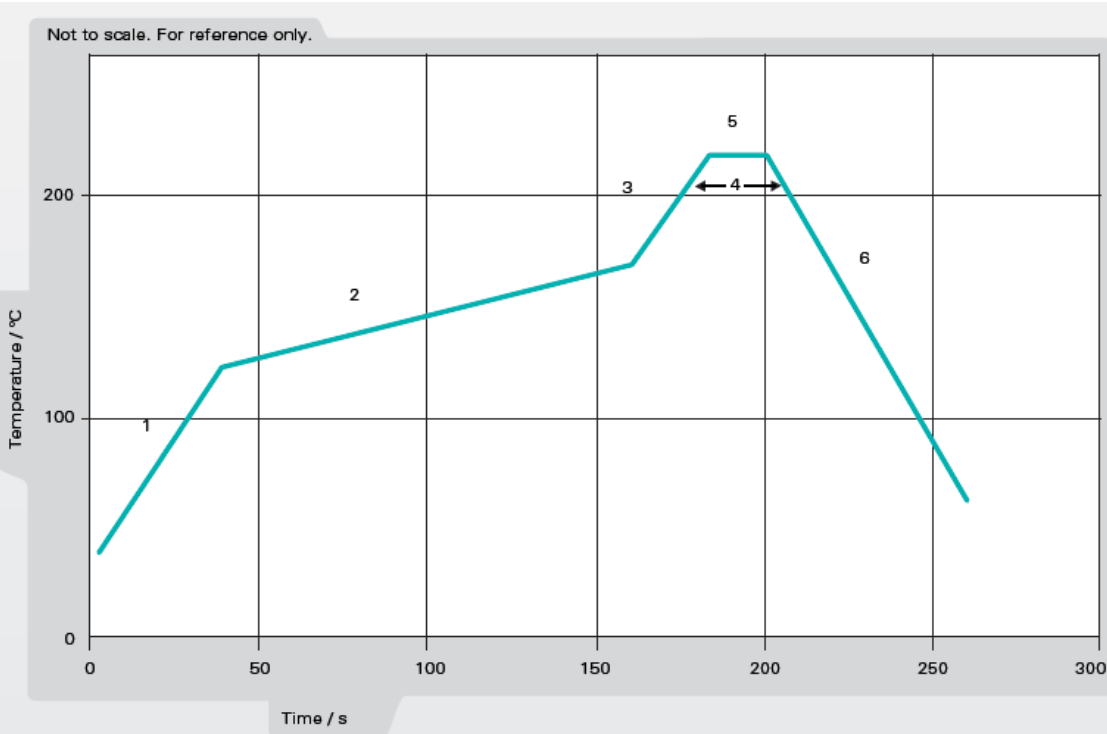


Figure 1. Minimum temperature profile recommendation for reflow soldering process

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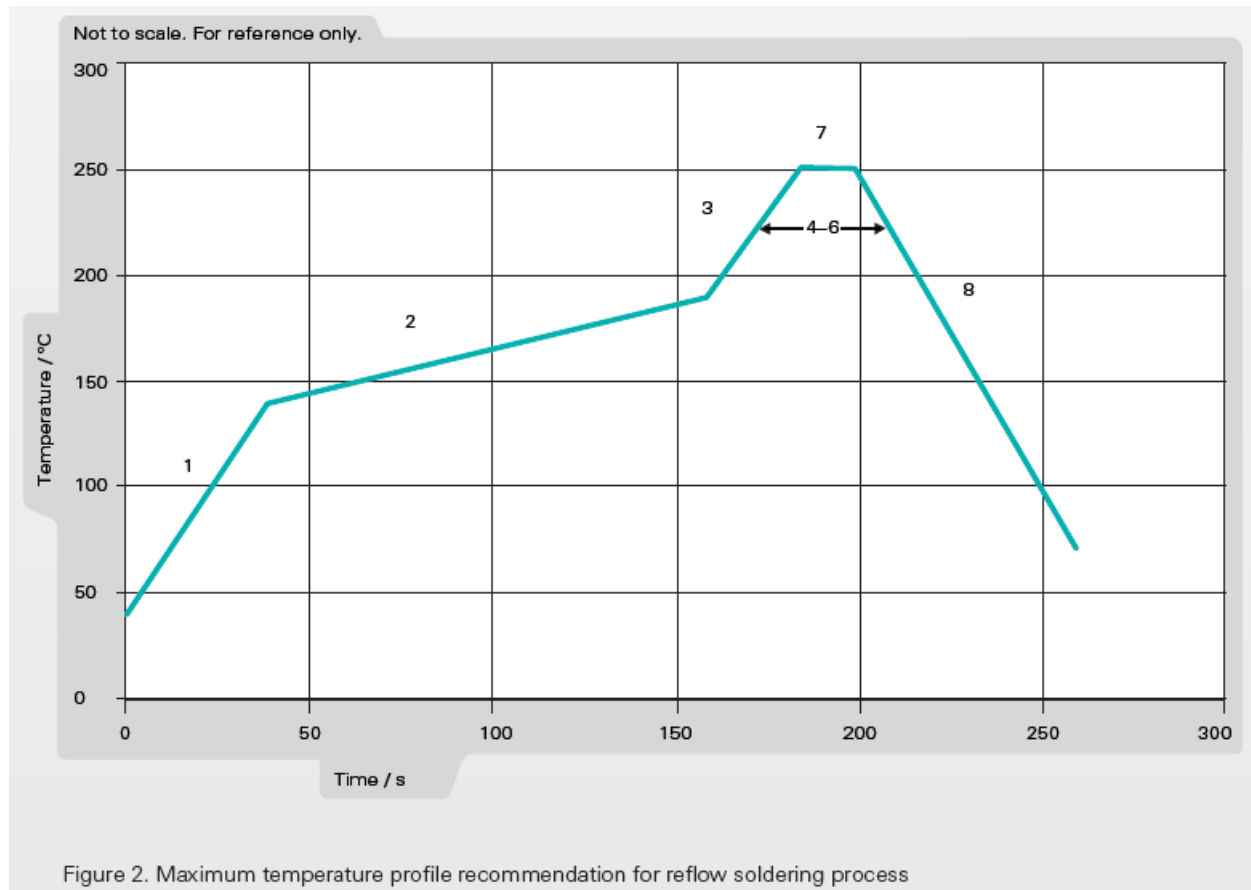
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2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 60 sec
5	Time above 230 °C	Max 50 sec
6	Time above 250 °C	Max 10 sec
7	Peak temperature in reflow	260 °C for 5 seconds
8	Temperature gradient in cooling	Max -5 °C/s



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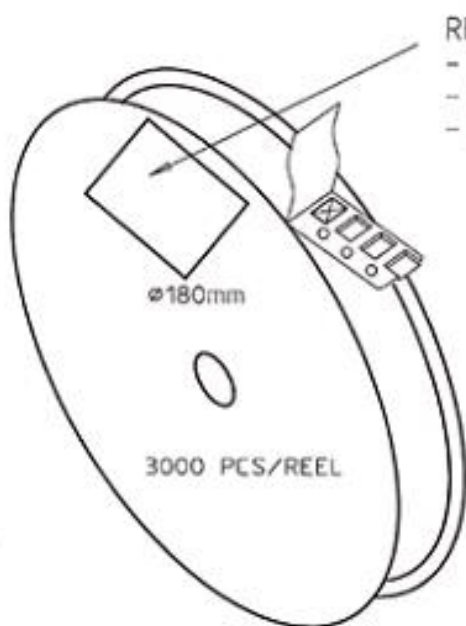
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PACKAGING

Taping package
 3000PCS/Reel
 30000PCS/Carton box



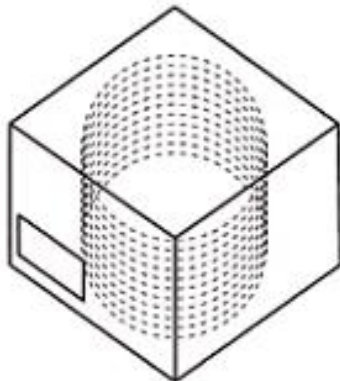
REEL LABEL INFORMATION:
 - TRACEABILITY
 - QUANTITY
 - PRODUCT CODE

CARRIER TAPE H85-00125
 width=8,00 depth=1,22
 COVER TAPE H85-00126
 width=5,60

LENGTH OF TAPE:

- Leader section: 50 empty cavities before component section
- Trailer section: 25 empty cavities after component section.

Empty part cavities at leader and trailer section of the tape must be sealed with top cover tape.



BOX H85-00128 (182x182x132)	1 pcs
- LABEL	1 pcs/BOX
REEL H85-00127 (D180, W12)	10 pcs
- REEL LABEL	1 pcs/REEL

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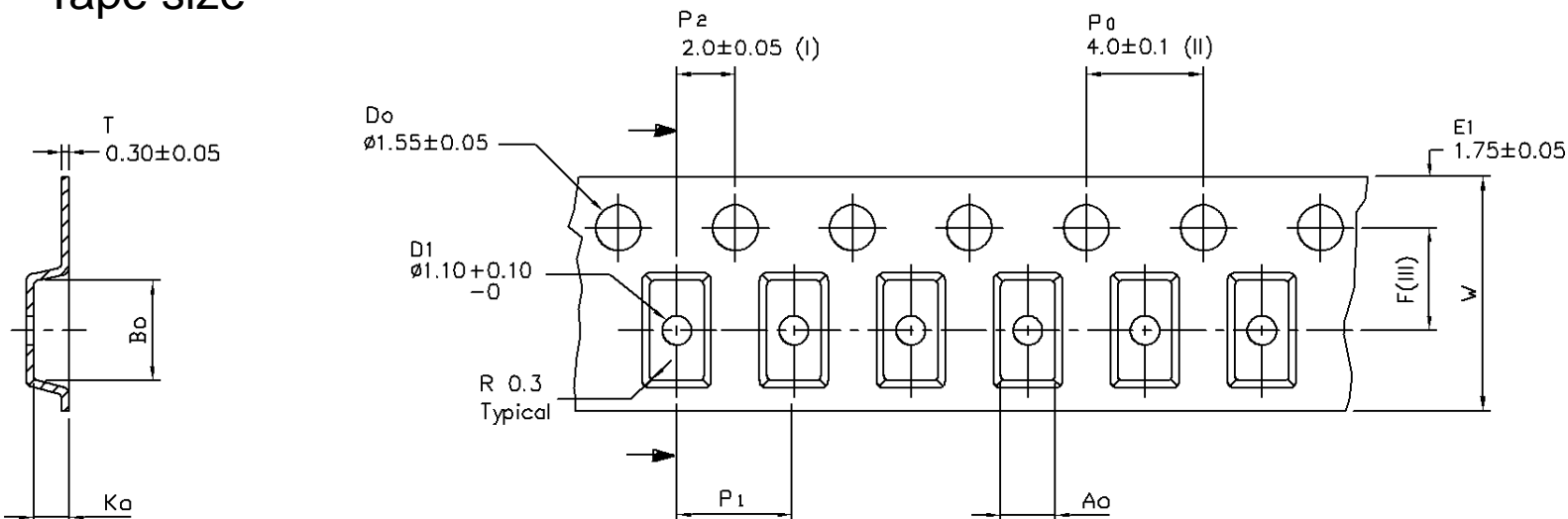
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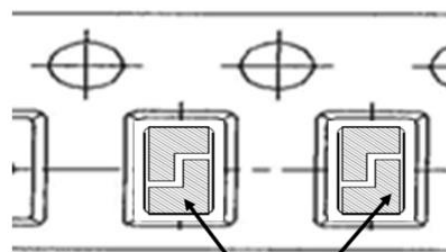
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PACKAGING

Tape size



Ao	1.85	+/- 0.1
Bo	3.43	+/- 0.1
Ko	1.22	+/- 0.1
F	3.50	+/- 0.05
P1	4.00	+/- 0.1
W	8.00	+/- 0.1



TOP VIEW OF THE CARRIER TAPE

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-  [PulseLarsen Antennas Information](#)

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-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
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